



SC0865F

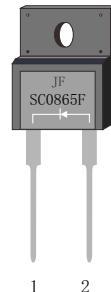
SILICON CARBIDE SCHOTTKY DIODE  
Reverse Voltage - 650V  
Forward Current -8A

## Features

- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- Positive Temperature Coefficient on VF
- Temperature-independent Switching
- 175°C Operating JunctionTemperature

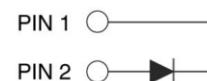
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## Benefits

- Replace Bipolar with Unipolar Device
- Reduction of Heat Sink Size
- Parallel Devices Without Thermal Runaway
- Essentially No Switching Losses



## Applications

- Switch Mode Power Supplies
- Power Factor Correction
- Motor drive, PV Inverter, Wind Power Station

$V_{RRM}$	=	650	V
$I_F(T_c \leq 85^\circ C)$	=	11	A
$Q_c$	=	22	nC

## Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
$V_{RRM}$	Repetitive Peak Reverse Voltage	650	V	$T_J = 25^\circ C$	
$V_{RSM}$	Surge Peak Reverse Voltage	650	V	$T_J = 25^\circ C$	
$V_R$	DC Blocking Voltage	650	V	$T_J = 25^\circ C$	
$I_F$	Forward Current	18 11 8	A	$T_c \leq 25^\circ C$ $T_c \leq 85^\circ C$ $T_c \leq 110^\circ C$	
$I_{FSM}$	Non-Repetitive Forward Surge Current	50	A	$T_J = 25^\circ C, t_p = 8.3\text{ms}, \text{Half Sine Wave}$	
$P_{tot}$	Power Dissipation	43	W	$T_J = 25^\circ C$	Fig.3
$T_J, T_{STG}$	Operating Junction and Storage Temperature	-55 to 175	°C		

### Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V <sub>F</sub>	Forward Voltage	1.4 1.7	1.65 2.3	V	I <sub>F</sub> = 8A, T <sub>J</sub> = 25°C I <sub>F</sub> = 8A, T <sub>J</sub> = 175°C	Fig.1
I <sub>R</sub>	Reverse Current	1 5	20 100	μA	V <sub>R</sub> = 650V, T <sub>J</sub> = 25°C V <sub>R</sub> = 650V, T <sub>J</sub> = 175°C	Fig.2
C	Total Capacitance	520 50 41	/	pF	V <sub>R</sub> = 0V, T <sub>J</sub> = 25°C, f = 1MHz V <sub>R</sub> = 200V, T <sub>J</sub> = 25°C, f = 1MHz V <sub>R</sub> = 400V, T <sub>J</sub> = 25°C, f = 1MHz	Fig.5
Q <sub>C</sub>	Total Capacitive Charge	22	/	nC	V <sub>R</sub> = 650V, I <sub>F</sub> = 8A di/dt = 200A/μs, T <sub>J</sub> = 25°C	Fig.4

### Thermal Characteristics

Symbol	Parameter	Typ.	Unit	Note
R <sub>θJC</sub>	Thermal Resistance from Junction to Case	3.5	°C/W	Fig.6
R <sub>θJA</sub>	Thermal Resistance from Junction to Ambient	80	°C/W	
T <sub>sold</sub>	Soldering Temperature	260	°C	

### Typical Performance

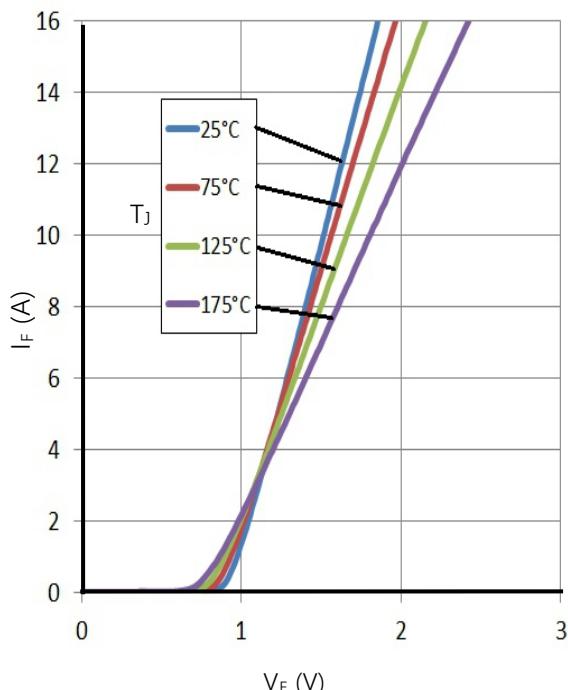


Figure 1. Forward Characteristics

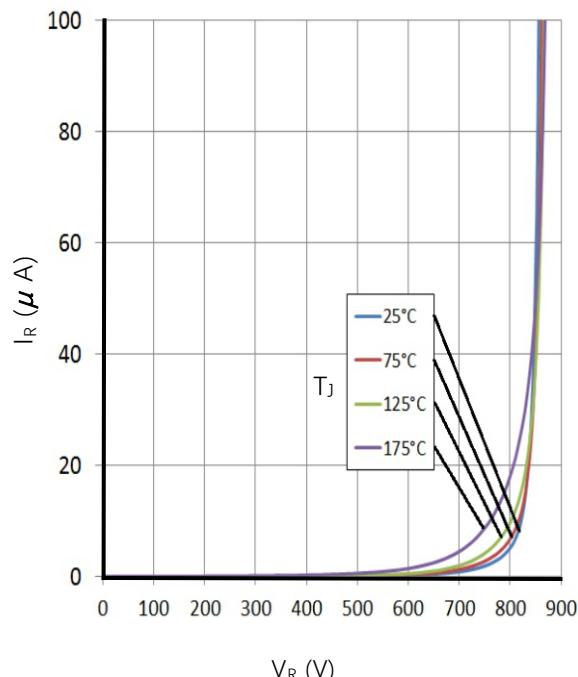


Figure 2. Reverse Characteristics

### Typical Performance

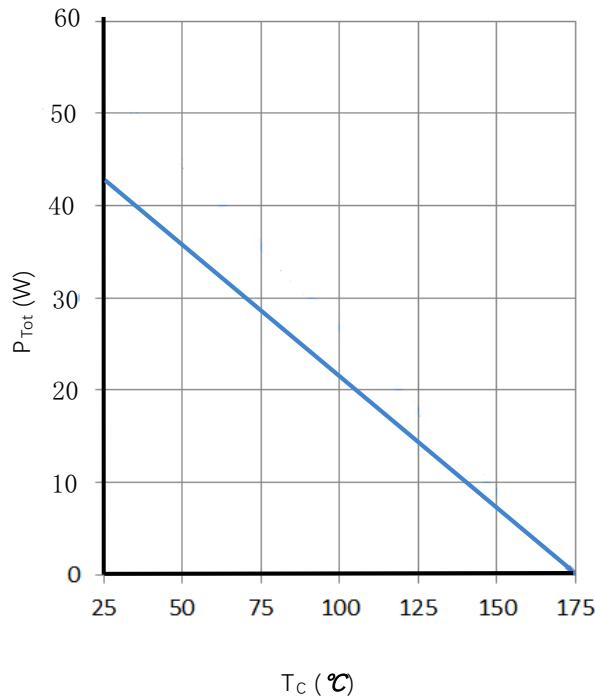


Figure 3. Power Derating

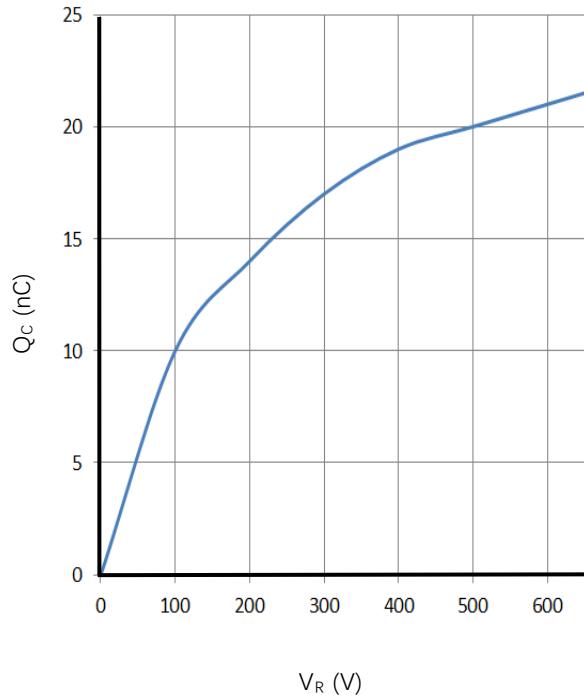


Figure 4. Total Capacitive Charge vs. Reverse Voltage

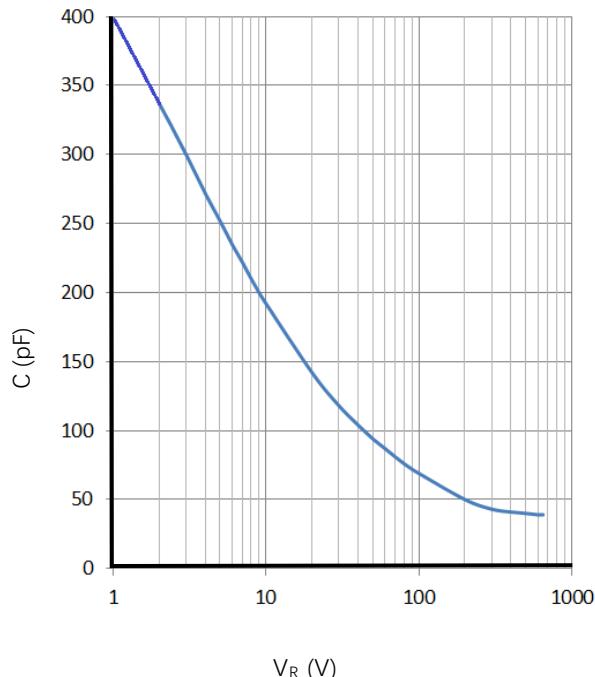


Figure 5. Total Capacitance vs. Reverse Voltage

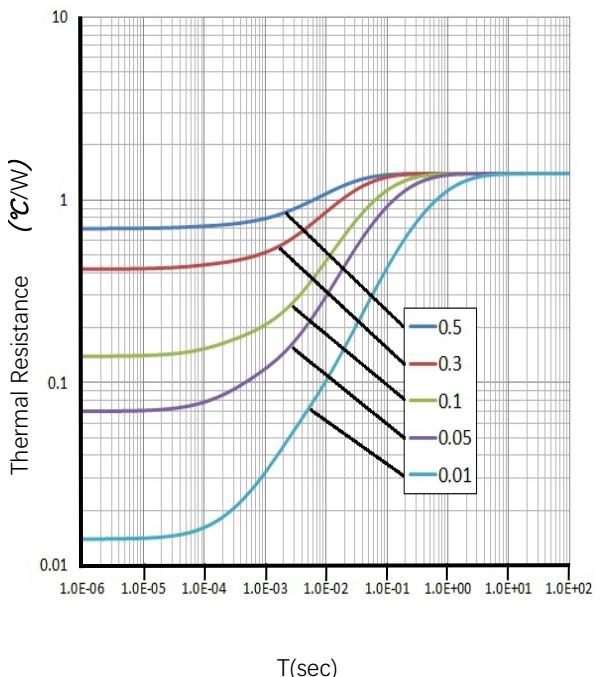
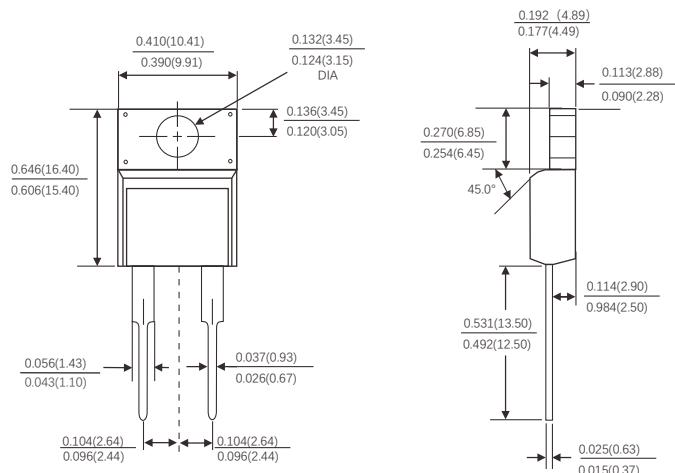


Figure 6. Transient Thermal Impedance

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Dimensions in inches and (millimeters)

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